

UNC-272M

Features

- u Approximately zero leaking current before clamping voltage
- Less decay at on/off state.
- u High capability to withstand repeated lightning strikes.
- Low electrode capacitance (≤1.0pF) and high isolation (≥100MΩ).
- u RoHS compliant.
- u Bilateral symmetrical.
- u Temperature, humidity and lightness insensitive.
- u Working temperature: -25 °C ~ +65 °C
- u Storage temperature: -25 °C ~ +85 °C
- u Meets MSL level 1, per J-STD-020



- u Power Supplies
- Motor sparks eliminating
- u Relay switching spark absorbing
- u Data line pulse guarding
- u Electronic devices requiring UL497A and UL497B compliant
- u Telephone/Fax/Modem
- u High frequency signal transmitters/receivers
- u Satellite antenna
- u Radio amplifiers
- u Alarm systems
- u Cathode ray tubes in Monitors/TVs

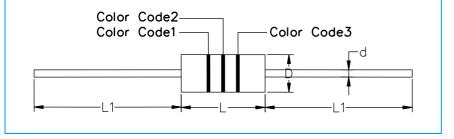
Part Numbering

<u>UNC</u> - <u>272</u> <u>M</u>

(1) (2) (3)

- (1) Series
- (2) V_S Voltage, e.g. 272=27X10²=2700V
- (3) Vs Voltage tolerance: M ±20%

Dimensions



Symbol	Inches	Millimeters
L1	1.102±0.118	28.0±3.0
L	0.197±0.012	5.0±0.3
d	0.020±0.002	0.5±0.05
D	0.122±0.012	3.1±0.3

UN Semiconductor Co., Ltd.





UNC-272M

Electrical Characteristics

Part Number	DC Spark-over Voltage Vs(V)	Minimum Insulation Resistance IR(OHM)/DC	Maximum Capacitance 1KHZ-6Vmax C (pF)	Surge Current Capacity 8/20 µS	AC Withstanding Voltage
UNC-272M	2700(2250~3240)	100M / 500V	1.0	3000A	AC1500V, 3min.

Color Code

Part Number	Color Code1	Color Code2	Color Code3
UNC-272M	Red	Purple	Red

Test Methods and Results

Items	Test Method	Standard
DC Spark-over Voltage	Measure starting discharge voltage (Vs) by gradually increasing applied DC voltage. Test current is 0.5mA max. And the DC voltage ascends up within 100V/s(Vs<1000V) or 500V/s(Vs≥1000V).	Rate-of-change, within±30%
Insulation Resistance	Measure the insulation resistance across the terminal at regular voltage. But the test voltage doesn't over the DC spark-over voltage.	insulation resistance & capacitance, conformed to rated spec.
Capacitance	Measure the electrostatic capacitance by applying a voltage of less than 6V (at 1KHz) between terminals.	
Static Life	10KV with 1500pf condenser is discharged through $2K\Omega$ resistor. 200 times at an interval of 10sec.	△Vs/Vs ≤30% Characteristics of other items must meet the specified value
Surge Current Capacity	1.2/50 μ s & 8/20 μ s, 3000A, electrically connected with a resistor (1~2 Ω), ±5 times, each time interval 60 seconds. Thereafter, outer appearance shall be visually examined.	No crack and no failures
Cold Resistance	Measurement after -40 $^{\circ}\!$	
Heat Resistance	Measurement after 125 $^{\circ}\!$	
Humidity Resistance	Measurement after humidity $90\sim95^{\circ}C(45^{\circ}C)$ /1000 HRS & normal temperature/2 HRS.	Features are conformed to rated spec
Temperature Cycle	10 times repetition of cycle -40 $^{\circ}$ C /30min \rightarrow normal, temp/2 min \rightarrow 125 $^{\circ}$ C/30min, measurement after normal temp/2 HRS.	
Solder Ability	Apply flux and immerse in molten solder 230±5℃ for 3sec up to the point of 1.5mm from body. Check for solder adhesion.	Lead wire is evenly covered by solder
Solder Heat	Measurement after lead wire is dipped up to the point of 1.5mm from body into 260±5 $^{\circ}$ C solder for 10sec	Conformed to rated spec
Pull Strength	Apply 0.5kg load for 10sec	
Flexural Strength	Bend lead wire at the point of 2mm from body under 0.25 load and back to its original point. Repeat 1 time.	Lead shall not pull out to snap

UN Semiconductor Co., Ltd.



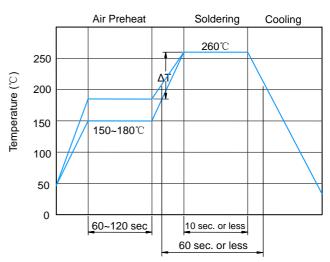
UNC-272M

Recommended Soldering Conditions

Flow Soldering Conditions

Air Preheat Soldering Cooling 250 250 150 150 150 100 50 60~120 sec 3~4 sec

Reflow Soldering Conditions



- 1) Time shown in the above figures is measured from the point when chip surface reaches temperature.
- 3) After soldering, do not force cool, allow the parts to cool gradually.

Hand Soldering

General attention to soldering

- **u** High soldering temperatures and long soldering times can cause leaching of the termination, decrease in adherence strength, and the change of characteristic may occur.
- u For soldering, please refer to the soldering curves above. However, please keep exposures to temperatures exceeding 200 ℃ to fewer than 50 seconds.
- **u** Please use a mild flux (containing less than 0.2wt% CI). Also, if the flux is water soluble, be sure to wash thoroughly to remove any residue from the underside of components that could affect resistance.

Cleaning

When using ultrasonic cleaning, the board may resonate if the output power is too high. Since this vibration can cause cracking or a decrease in the adherence of the termination, we recommend that you use the conditions below:

Frequency: 40kHz max.

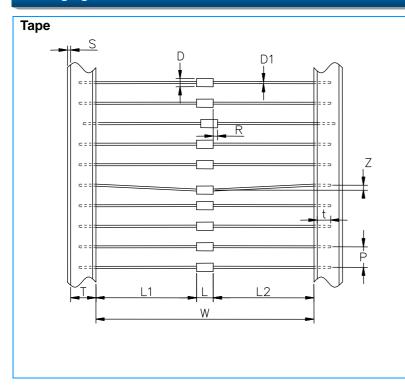
Output power: 20W/liter

Cleaning time: 5 minutes max.

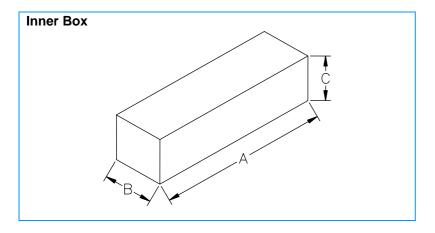


UNC-272M

Packaging



Symbol	Dimension (mm)
w	52+2.0/-1.0
Р	5.0±0.5
Т	6.0±1.0
Z	1.2 Max
L1-L2	1.0 Max
s	0.8 Max
t	3.2 Max
L	5.0±0.3
D1	Ф0.5±0.05
D	Ф3.1±0.5
R	1.0 Max



Item	Description	
Length	A=255 mm	
Width	B=75 mm	
Height	C=68 mm	
Quantity	1500 PCS	
Package	There are upper and bottom board to protect the parts from damage.	